NCE N-Channel Super Trench Power MOSFET

Description

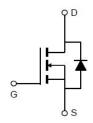
The NCEP15T14T uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

- $V_{DS} = 150V, I_D = 140A$ $R_{DS(ON)} < 6.4 \text{m}\Omega @ V_{GS} = 10V$
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



Schematic diagram



TO-247 top view

100% UIS TESTED!

100% AVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP15T14T	NCEP15T14T	TO-247	-	-	-

Absolute Maximum Ratings (T_C=25 ℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	150	V
Gate-Source Voltage	V _G s	±20	V
Drain Current-Continuous	I _D	140	Α
Drain Current-Continuous(T _C =100℃)	I _D (100°C)	100	А
Pulsed Drain Current	I _{DM}	560	А
Maximum Power Dissipation	P _D	320	W
Derating factor		2.1	W/℃
Single pulse avalanche energy (Note 1)	Eas	1296	mJ
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 175	℃

Thermal Characteristic

Thermal Resistance, Junction-to-Case	R _{eJC}	0.47	°C/W



Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	150	-	-	V	
Zero Gate Voltage Drain Current	IDSS	V _{DS} =150V,V _{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA	
On Characteristics							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=250\mu A$	2.0	3.0	4.0	V	
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =70A	-	5.6	6.4	mΩ	
Forward Transconductance	G FS	V _{DS} =10V,I _D =70A	70	-	-	S	
Dynamic Characteristics							
Input Capacitance	C _{lss}	\\ 75\\\\ 0\\	-	6000	-	PF	
Output Capacitance	Coss	V_{DS} =75 V , V_{GS} =0 V ,	-	690	-	PF	
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	24	-	PF	
Switching Characteristics (Note 2)			<u> </u>				
Turn-on Delay Time	t _{d(on)}		-	26	-	nS	
Turn-on Rise Time	t _r	V_{DD} =75 V , I_D =70 A	-	36	-	nS	
Turn-Off Delay Time	t _{d(off)}	$V_{GS}\text{=}10V,R_{G}\text{=}4.7\Omega$	-	47	-	nS	
Turn-Off Fall Time	t _f		-	15	-	nS	
Total Gate Charge	Qg	\/ -75\/ -704	-	80	-	nC	
Gate-Source Charge	Q _{gs}	$V_{DS}=75V,I_{D}=70A,$	-	32	-	nC	
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	22	-	nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _F = I _S	-		1.2	V	
Diode Forward Current	Is		-	-	140	Α	
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = I _S	-	140		nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/μs	-	498		nC	

Notes:

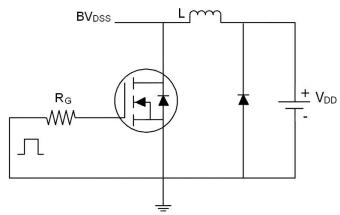
^{1.} EAS condition : Tj=25 $^{\circ}\text{C}$,VDD=50V,VG=10V,L=0.5mH,Rg=25 Ω

^{2.} Guaranteed by design, not subject to production

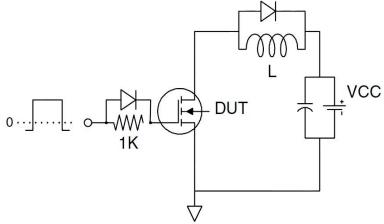
^{3.} These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsin k, assuming a maximum junction temperature of TJ(MAX)=175° C. The SOA curve provides a single pulse rating.

Test Circuit

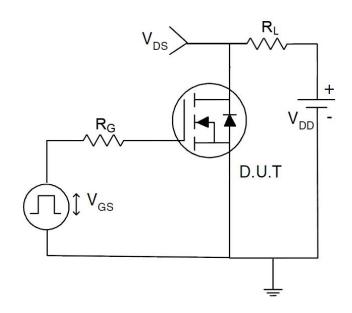
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





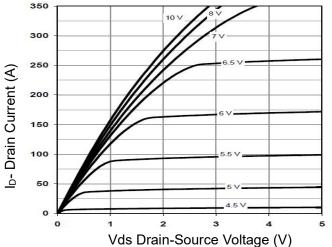


Figure 1 Output Characteristics

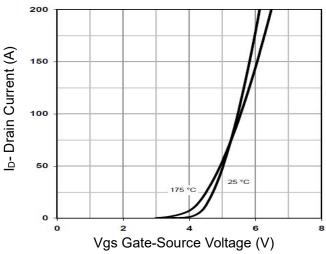


Figure 2 Transfer Characteristics

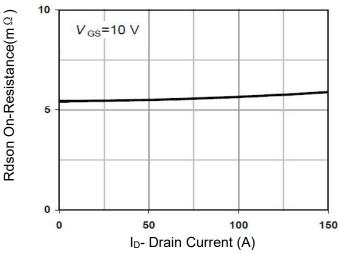


Figure 3 Rdson- Drain Current

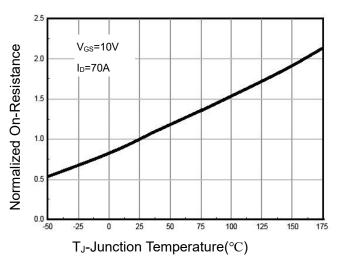


Figure 4 Rdson-JunctionTemperature

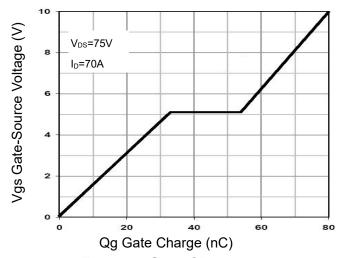


Figure 5 Gate Charge

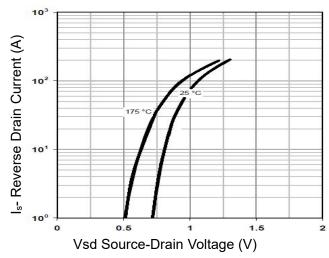
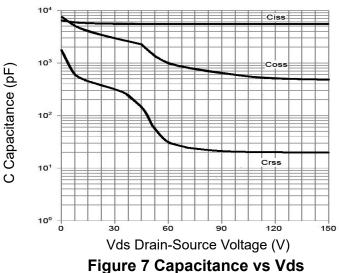
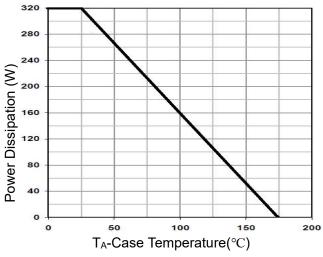


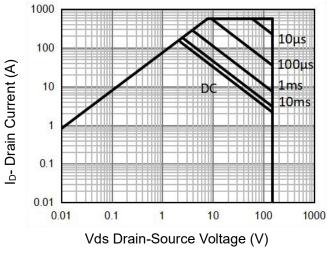
Figure 6 Source- Drain Diode Forward





Is Figure 9 Power De-rating

200



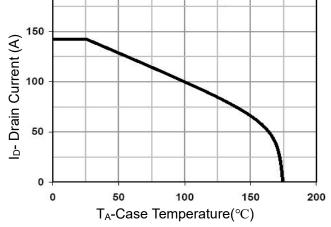
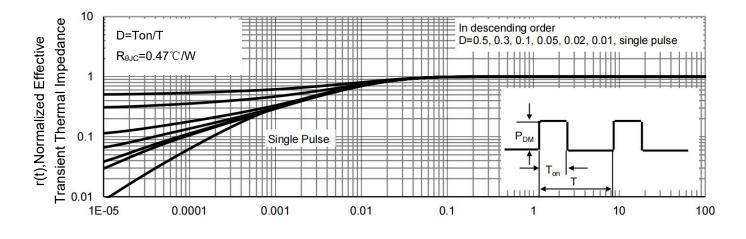


Figure 8 Safe Operation Area (Note 3)

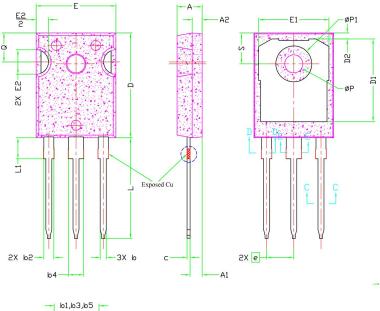
Figure 10 Current De-rating



Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance

TO-247(G) Package Information







Section C--C,D--D,E-E

	I	NOTES		
SYMBOL	MIN.	NOM.	MAX.	NOTES
Α	4.83	5.02	5.21	
A1	2.29	2.41	2.55	
A2	1,50	2,00	2,49	
b	1.12	1.20	1.33	
b1	1.12	1,20	1,28	
b2	1,91	2,00	2,39	6
b3	1.91	2.00	2.34	
b4	2.87	3,00	3,22	6, 8
b5	2.87	3.00	3.18	
С	0.55	0.60	0.69	6
c1	0.55	0.60	0.65	
D	20.80	20.95	21.10	4
D1	16.25	16.55	17.65	5
D2	0.51	1.19	1.35	
Е	15.75	15.94	16.13	4
E1	13.46	14.02	14.16	5
E2	4.32	4.91	5.49	3
е	5.44BSC			
L	19.81	20.07	20.32	
L1	4.10	4.19	4.40	6
ØP	3.56	3.61	3.65	7
ØP1	7.19REF.			
Q	5.39	5.79	6.20	
s	6.04	6.17	6.30	

- Note:

 1. Package Reference: JEDEC TO247, Variation AD.

 2. All Dimensions Are In mm.

 3. Slot Required, Notch May Be Rounded

 4. Dimension D & E Do Not Include Mold Flash, Mold Flash Shall
 Not Exceed 0.127mm Pre Side. These Dimensions Are Measured
 At The Outermost Extreme Of The Plastic Body.

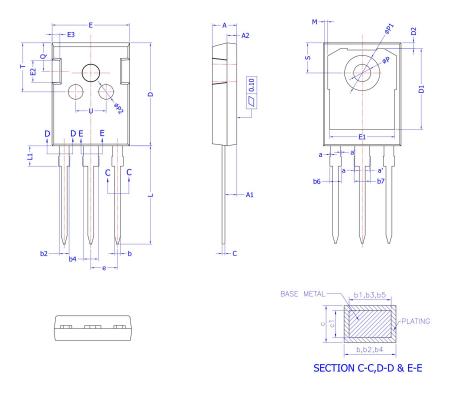
 5. Thermal Pad Contour Optional Within Dimension DI & E1.

 6. Lead Finish Uncontrolled In L1.

 7. ØP To Have A Maximum Draft Angle Of 1.5° To The Top Of The
 Part With A Maximum Hole Diameter Of 3.91mm.

 8. Dimension "b2" And "b4" Does Not Include Dambar Protrusion.
 Allowable Dambar Protrusion Shall Be 0.10mm Total In Excess Of
 "b2" And "b4" Dimension At Maximum Material Condition.

TO-247(P) Package Information

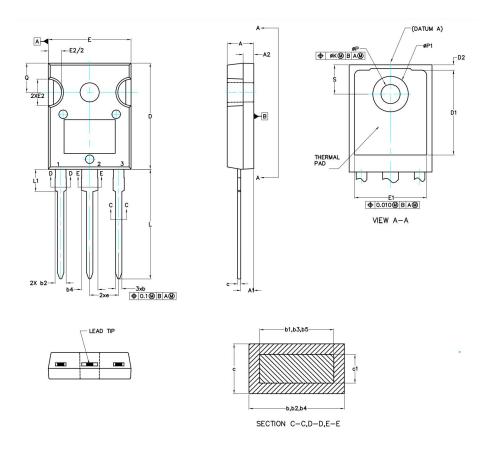


COMMON DIMENSIONS
(UNITS OF MEASURE =MILLIMETER)

SYMBOL	MIN	NOM	MAX
Α	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
a	0		0.15
a'	0		0.15
b	1.16		1.26
b1	1.15	1.2	1.22
b2	1.96		2.06
b3	1.95	2.00	2.02
b4	2.96		3.06
b5	2.96	3.00	3.02
b6			2.25
b7			3.25
С	0.59		0.66
c1	0.58	0.60	0.62
D	20.90	21.00	21.10
D1	16.25	16.55	16.85
D2	1.05	1.17	1.35
Е	15.70	15.80	15.90
E1	13.10	13.30	13.50
E2	4.40	4.50	4.60
E3	2.40	2.50	2.60
е		5.436 BSC	
L	19.80	19.92	20.10
L1			4.30
М	0.35		0.95
Р	3.40	3.50	3.60
P1	7.00		7.40
P2	2.40	2.50	2.60
Q	5.60		6.00
S	6.05	6.15	6.25
Т	9.80		10.20
U	6.00		6.40

NOTES: ALL DIMENSIONS REFER TO JEDEC STANDARD TO-247 AD DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. EJEDTION MARK DEPTH $0.10^{+0.15}_{-0.10}$

TO-247(J) Package Information



Ŷ	DIMENSIONS						
MB	m	ım	inch				
NY-MBOLIN	MIN.	MAX.	MIN.	MAX.			
Α	4.83	5.13	0.190	0.20			
A1	2.21	2.59	0.087	0.102			
A2	1.50	2.49	0.059	0.098			
b	0.99	1.40	0.039	0.055			
b1	0.99	1.35	0.039	0.053			
b2	1.65	2.39	0.065	0.094			
Ь3	1.65	2.34	0.065	0.092			
b4	2.59	3.43	0.102	0.135			
b5	2.59	3.38	0.102	0.133			
С	0.38	0.89	0.015	0.035			
с1	0.38	0.84	0.015	0.033			
D	19.71	20.70	0.776	0.815			
D1	13.08		0.515				
D2	0.51	1.35	0.020	0.053			
Ε	15.29	15.87	0.602	0.625			
E1	13.46		0.530				
E2	4.52	5.49	0.178	0.216			
е	5.46BSC		0.215BSC				
L	19.57	21.00	0.780	0.827			
L1	3.71	4.29	0.146	0.169			
ØΡ	3.56	3.66	0.140	0.144			
øP1	_	7.39		0.291			
Q	5.31	5.69	0.209	0.224			
S	5.51BSC		0.217BSC				

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